## APPENDIX A

91. (Amended) An improved method for stabilizing a spinous process relative
to another spinous process, said method being of the type wherein a device is
implanted between said spinous process and said another spinous process, wherein
said improvement comprises:
introducing between said spinous process and said another spinous
process a device which is conformable comformable in situ to the shape of at
least one of said spinous process and said another spinous process.
93. (Amended) An improved method for stabilizing a spinous process relative
to another spinous process, said method being of the type wherein a device is
implanted between said spinous process and said another spinous process, wherein
said improvement comprises:
introducing between said spinous process and said another spinous
process a device having a sealable cavity which is fillable with a material.
94. (Amended) An improved method for stabilizing a spinous process relative
to another spinous process, said method being of the type wherein a device is
implanted between said spinous process and said another spinous process, wherein
said improvement comprises:
introducing between said spinous process and said another spinous
process a device which is has flexible walls defining a sealable cavity capable of
receiving being filled with a material.
100. (Amended) The improved method of claim 98 wherein:
said introducing step includes using a material which changes shape
according according to temperature.
106. (Amended) The method of claim 102 further including:
a said removing step allow the device to reconfigure about one of said
eningue process and said another spingue process

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- 1 113. (Amended) An improved method for stabilizing a spinous process relative
- 2 to another spinous process, said method being of the type wherein a device is
- 3 implanted between said spinous process and said another spinous process, wherein
- 4 said improvement comprises:
- 5 introducing between the spinous process and the another spinous <del>processes</del>
- 6 process a device without altering the spinous processes.

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